

ORIGAMI XP





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SWISS MADE



Origami XP is the first all-in-one, single-box, **microjoule femtosecond** laser available on the market. The laser head, controller and air-cooling system are all integrated in one small and robust package ready for fast integration. Its footprint is so small (280 x 498 x 155 mm) that it even fits into a hand-luggage. The system is based on a simple and compact chirped pulse amplification system capable of delivering > 40 μ J pulse energy, 4 W average power with pulse duration below 400 fs. The laser platform offers excellent pointing stability in time as well as against ambient temperature fluctuations. Origami XP has been designed for easy and cost-effective integration. It is delivered with removable handles and offers full remote control capabilities. A simple through-hole mounting system and high precision mechanical referencing planes ensure straightforward drop-in installation.

OPTIONS:

- + Up to 60 μJ pulse energy
- + Up to 5 W output power
- + UVC 258 nm
- + Synchronization to external clock
- + Picosecond operation
- + Circular polarization
- + Water cooling

MAIN APPLICATIONS:

- + High precision laser surgery
- + Micromachining
- + Plasma generation
- + Nonlinear optics
- + LIBS
- + THz generation

OUTSTANDING FEATURES:

- + Air-cooled, single-box, dust sealed OEM package
- + Mountable in any direction
- + Real-time pulse energy measurement and control
- + Burst mode
- + Excellent pulse quality
- + Outstanding energy and pointing stability
- + Maintenance free no alignment required
- + Complete remote control
- + 24/7 operation



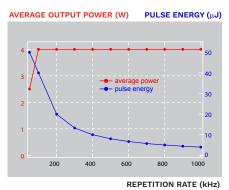
Specifications subject to change without notice, May 2017

ISO 9001 : 2008 ISO 13485 : 2012

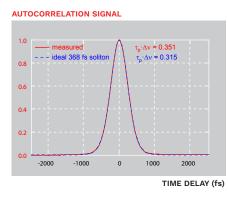
	ORIGAMI - 03 XP	ORIGAMI - 05 XP	ORIGAMI -10 XP	
CENTER WAVELENGTH	343 nm	512 nm	1030 nm	
PULSE DURATION	<400 fs	<400 fs	<400 fs	
AVG. OUTPUT POWER [UP TO]	1 W	2 W	4 W	
PULSE ENERGY [UP TO]	10 μJ	20 μJ	40 μJ	
PEAK POWER [UP TO]	13 MW	35 MW	100 MW	
PULSE REPETITION RATE	single shot – 1 MHz			
SPECTRAL BANDWIDTH	< 1.8 nm	< 2.5 nm	< 4 nm	
BEAM QUALITY	M ² < 1.4, TEM ₀₀	M ² < 1.2, TEM ₀₀	M ² < 1.2, TEM ₀₀	
ELLIPTICITY	< 1.3	< 1.1	< 1.1	
AMPLITUDE NOISE [12 h]	< 4.0 % rms	< 2.0 % rms	< 1.0 % rms	
PER	> 23 dB vertical			
ENERGY CONTRAST	23 dB			
POINTING STABILITY	< 30 μrad rms (12 h) const. temp., < 5 μrad/ °C 18-35°C			
LASER OUTPUT	collimated free space			
ENVIRONMENTAL				
WARM-UP TIME	< 10 minutes			
OPERATION TEMPERATURE	18 °C – 32 °C			
STORAGE TEMPERATURE	- 20 °C – 65 °C			
ON/OFF CYCLES	> 10000			
MECHANICAL				
SIZE LASER SYSTEM	280 x 498 x 156 mm³			
WEIGHT LASER SYSTEM	32 kg			
ELECTRICAL				
POWER SUPPLY	24 VDC / 20 A or 90 - 264 VAC, 47 - 63 Hz			
POWER CONSUMPTION		< 500 W		
COOLING				
LASER SYSTEM		air cooled or water cooled		

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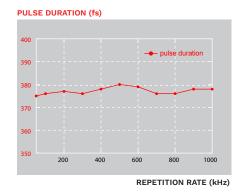
OUTPUT POWER VS REPETITION RATE



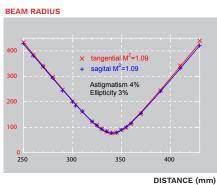
PULSE PROFILE



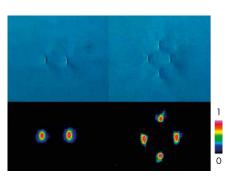
PULSE DURATION VS REPETITION RATE



BEAM QUALITY



APPLICATION



DIRECT LASER INSCRIPTION IN BULK ACRYLIC GLASS USING ORIGAMI - 10 XP. © W. - H. Yuan et al., Optical Materials 49, 110-115, 2015

IEC COMPLIANT PRODUCT

SHOCK & VIBRATION TEST IEC 60068-2-27: 2008 IEC 60068-2-6: 2007

> ELECTROMAGNETIC COMPATIBILITY IEC 61010-1: 2010 IEC 61326-1: 2012

LASER RADIATION SAFETY IEC 60825-1: 2014